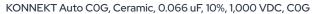
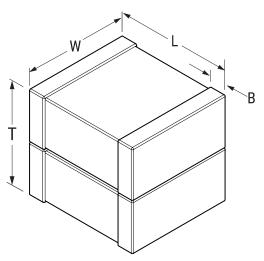
C2220C663KDGLCAUTO







Click here for the 3D model	Click	here	for	the	3D	model
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L	5.7mm +/-0.4mm
W	5mm +/-0.4mm
Т	5.1mm +/-0.4mm
В	0.6mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	300

General Information	
Series	KONNEKT Auto COG
Style	KONNEKT
Description	SMD, MLCC, KONNEKT, Ultra- Stable, Class I
Features	High Density Packaging
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200
AEC-Q200	Yes
Typical Component Weight	652 mg
Chip Size	2220-2
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.066 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1,200 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 PPM/C
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	15.152 GOhms

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